Code No.: 13464 N/O

VASAVI COLLEGE OF ENGINEERING (AUTONOMOUS), HYDERABAD

Accredited by NAAC with A++ Grade

B.E. (E.C.E.) III-Semester Main & Backlog Examinations, Jan./Feb.-2024

Electronic Devices

Time: 3 hours

Max. Marks: 60

Note: Answer all questions from Part-A and any FIVE from Part-B

Part-A $(10 \times 2 = 20 \text{ Marks})$

Q. No.	Stem of the question	M	L	СО	PO	PSO
1.	Define Diffusion current and what is the role of it in PN -junction formation?	2	1	1	1	1
2.	Define Velocity Saturation in semiconductors.	2	1	1	1	1
3.	Is it true that avalanche breakdown decreases by increasing temperature? Justify your answer.	2	2	2	1	1
4.	The reverse saturation current of a Germanium diode at 30°C is 0.1µA. What would be the approximate value of the current if the temperature is increased by 22°C.	2	3	3	1,2	1
5.	In the circuit shown below, the knee current of the ideal Zener diode is 10 mA. To maintain 5 V across RL, the minimum value of RL in Ω and the minimum power rating of the Zener diode in mW, respectively are	2	3	3	1,2	
		dr dow				
	$100\Omega \lessapprox I_{Load}$ $V_Z = 5V \lessapprox R_L$	n gelsnov				
	$V_z = 5V \stackrel{?}{\searrow} 1$	nt ap				
6.	Schottky Barrier Diode is better suited for high frequency switching operations. True or False? Justify the answer.	2	2	2	1	1
7.	Draw Ebers-Moll model of a NPN transistor and write the necessary equations.	2	2	2	1	1
8.	Define threshold and pinch-off voltages in MOSFET.	2	1	2	1	1
9.	What is twin tub process in CMOS fabrication?	2	1	5	1	1
10.	Distinguish FinFET and MOSFET technologies with respect to package density and power dissipation.	2	2	4	1	1
	Part-B $(5 \times 8 = 40 \text{ Marks})$					
11. a)	Calculate the built-in voltage of a junction in which the p and n regions are doped equally with 10 ¹⁶ atoms /cm ³ , assume	4	3	1	1,2	1
	n_i = 1.5×10 ¹⁰ /cm ³ .with the terminals left open , what is the width of the depletion region , and how far does it extend into the p and n regions? If		etile ,			

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the cross-sectional area of the junction is 100µm², find the magnitude of the charge stored on either side of the junction.	- TI				
Distinguish phonon scattering and ionized impurity scattering.	4	2	1	1,2	1
Show that the diode current equation is $I = I_0[e^{(V/\eta VT)} - 1]$ when the diode is forward biased	4	3	2	1,2	1
What do you understand from Switching Characteristics of PN diode? Elaborate with necessary wave forms.	4	3	2	1,2	1
Design a DC power supply with 9V and 200mA specification using π -filter.	4	4	3	1,2,3	1
Draw the characteristics of Tunnel diode and explain the operation with the help of energy band diagrams.	4	2	2	1,2	1
Explain the operation of BJT in CB configuration with the help of its input and output characteristics.	4	1	2	1,2	1
List the MOS structure operating modes and explain them with the aid of parallel plate capacitor.	4	2	2	1,2	1
CMOS invertor is advantages when compared to BJT invertor & NMOS invertor with respect to package density and power dissipation. True or False? Justify the answer with proper reasoning.	4	3	4	1,2	1
Discuss the process of oxidation, photolithography and masking used in fabrication of Electronic Devices.	4	1	5	1,2	1
Explain the process of carrier generation and recombination that takes place in semiconductors with the help of relevant equations.	4	2	1	1,2	1
Show that storage capacitance of a P+N junction is $C_D = \tau_T \; / \; \eta \; V_T$	4	3	2	1,2	1
Answer any two of the following:					
Design a circuit that clips any portion of the input AC waveform below 4 volts as shown below.	4	3	3	1,2,3	1
6 V _{RMS} Clipping Circuit	4		4	1.2	1
	4	2	4	1,2	1
List the advantages of MOS technology over Bipolar technology	Line				
Explain the operation of CMOS invertor with capacitive load and draw	4	2	2	1,2	1
	the charge stored on either side of the junction. Distinguish phonon scattering and ionized impurity scattering. Show that the diode current equation is $I = I_0[e^{(V/\eta VT)} - 1]$ when the diode is forward biased What do you understand from Switching Characteristics of PN diode? Elaborate with necessary wave forms. Design a DC power supply with 9V and 200mA specification using π -filter. Draw the characteristics of Tunnel diode and explain the operation with the help of energy band diagrams. Explain the operation of BJT in CB configuration with the help of its input and output characteristics. List the MOS structure operating modes and explain them with the aid of parallel plate capacitor. CMOS invertor is advantages when compared to BJT invertor & NMOS invertor with respect to package density and power dissipation. True or False? Justify the answer with proper reasoning. Discuss the process of oxidation, photolithography and masking used in fabrication of Electronic Devices. 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Marks; L: Bloom's Taxonomy Level; CO; Course Outcome; PO: Programme Outcome

i)	Blooms Taxonomy Level – 1	20%
ii)	Blooms Taxonomy Level – 2	40%
iii)	Blooms Taxonomy Level – 3 & 4	40%

